



## Removing charge at IC socket

### OUTLINE / PREVIOUS

**Customer: Semiconductor equipment manufacturer**

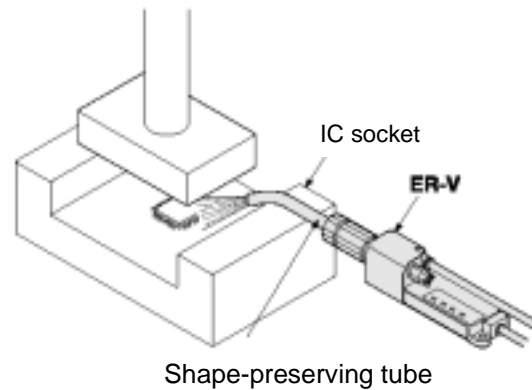
**Process: Package test process**

Charges are to be removed at chip which occurs in desorption of IC socket.

### PROBLEM

Static remover is required which blows ion air aiming at the chip on a narrow gap of IC socket.

### SOLUTION



### MODEL / HOW TO

**ER-VS01 ER-VAJK ER-VAK10**

Install nozzle head very close to the object. Pinpoint and effective static removal is possible.

### BENEFIT 1 Shape-preserving tube

Shape-preserving tube **ER-VAK10** (tube length: 112mm) can be bent easily and its shape is kept, which requires no fixing of the tube. We also have **ER-VAK30** (tube length: 312mm) and **ER-VAK50** (tube length: 512mm).

### BENEFIT 2 Compact in size

**ER-VS01** is as compact as W109 x H28 x D27mm, which can be installed closer to the object.

### BENEFIT 3 Discharge halt input

**ER-VS01** can operate to turn ON/ OFF of discharge with input signals from external device. Sensors can be used to detect the objects so that the ion air is generated only when required.

